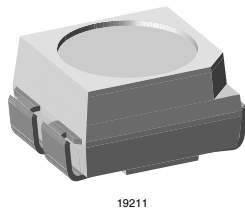


Bicolor SMD LED PLCC-4



19211

DESCRIPTION

These devices have been designed to meet the increasing demand for surface mounting technology.

The package of the VLMRY3420 is the PLCC-4.

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

This SMD device consists of a amber and yellow chip. So it is possible to choose the color in one device.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD PLCC-4
- Product series: bicolor
- Angle of half intensity: $\pm 60^\circ$

| PARTS TABLE | | |
|----------------|--|-----------------|
| PART | COLOR, LUMINOUS INTENSITY | TECHNOLOGY |
| VLMRY3420-GS08 | Amber, $I_V = (355 \text{ to } 900) \text{ mcd}$ Yellow, $I_V = (560 \text{ to } 1120) \text{ mcd}$ | AllnGaP on GaAs |
| VLMRY3420-GS18 | Amber, $I_V = (355 \text{ to } 900) \text{ mcd}$ Yellow, $I_V = (560 \text{ to } 1120) \text{ mcd}$ | AllnGaP on GaAs |

FEATURES

- SMD LED with exceptional brightness
- Multicolored
- Luminous intensity categorized
- EIA and ICE standard package
- Compatible with automatic placement equipment
- Compatible with IR reflow, vapor phase and wave soldering processes according to CECC 00802 and J-STD-020C
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit
 $I_{Vmax}/I_{Vmin} \leq 1.6$
- Lead (Pb)-free device
- Preconditioning: according to JEDEC level 2a
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- ESD-withstand voltage:
up to 2 kV according to JESD22-A114-B



APPLICATIONS

- Automotive: backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches and symbols
- General use



| ABSOLUTE MAXIMUM RATINGS ¹⁾ VLMRY3420 | | | | | |
|--|---|------------|-------------------|---------------|------------------|
| PARAMETER | TEST CONDITION | | SYMBOL | VALUE | UNIT |
| Reverse voltage per diode ²⁾ | $I_R = 10 \mu\text{A}$ | | V_R | 5 | V |
| DC Forward current per diode | $T_{\text{amb}} \leq 65 \text{ }^\circ\text{C}$ | | I_F | 50 | mA |
| Surge forward current per diode | | | I_{FSM} | 0.1 | A |
| Power dissipation per diode | | | P_V | 130 | mW |
| Junction temperature | | | T_j | 125 | $^\circ\text{C}$ |
| Operating temperature range | | | T_{amb} | - 40 to + 100 | $^\circ\text{C}$ |
| Storage temperature range | | | T_{stg} | - 40 to + 100 | $^\circ\text{C}$ |
| Thermal resistance junction/ ambient | mounted on PC board | 1 chip on | R_{thJA} | 480 | K/W |
| | (pad size > 16 mm ²) | 2 chips on | | 650 | |

Note:

- $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$, unless otherwise specified
- Driving the LED in reverse direction is suitable for short term application

| OPTICAL AND ELECTRICAL CHARACTERISTICS ¹⁾ VLMRY3420, AMBER | | | | | | | |
|---|------------------------------|-----------|-------------|-----|----------|-----|---------------|
| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN | TYP. | MAX | UNIT |
| Luminous intensity | $I_F = 50 \text{ mA}$ | VLMRY3420 | I_V | 355 | | 900 | mcd |
| Dominant wavelength | $I_F = 50 \text{ mA}$ | | λ_d | | 617 | | nm |
| Peak wavelength | $I_F = 50 \text{ mA}$ | | λ_p | | 624 | | nm |
| Angle of half intensity | $I_F = 50 \text{ mA}$ | | ϕ | | ± 60 | | deg |
| Forward voltage | $I_F = 50 \text{ mA}$ | | V_F | | 2.1 | 2.6 | V |
| Reverse current | $V_R = 5 \text{ V}$ | | I_R | | | 10 | μA |
| Junction capacitance | $V_R = 0, f = 1 \text{ MHz}$ | | C_j | | 15 | | pF |

Note:

- $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$, unless otherwise specified

| OPTICAL AND ELECTRICAL CHARACTERISTICS ¹⁾ VLMRY3420, YELLOW | | | | | | | |
|--|------------------------------|-----------|-------------|-----|----------|------|---------------|
| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN | TYP. | MAX | UNIT |
| Luminous intensity | $I_F = 50 \text{ mA}$ | VLMRY3420 | I_V | 560 | | 1120 | mcd |
| Dominant wavelength | $I_F = 50 \text{ mA}$ | | λ_d | 581 | 588 | 594 | nm |
| Peak wavelength | $I_F = 50 \text{ mA}$ | | λ_p | | 590 | | nm |
| Angle of half intensity | $I_F = 50 \text{ mA}$ | | ϕ | | ± 60 | | deg |
| Forward voltage | $I_F = 50 \text{ mA}$ | | V_F | | 2.1 | 2.6 | V |
| Reverse current | $V_R = 5 \text{ V}$ | | I_R | | | 10 | μA |
| Junction capacitance | $V_R = 0, f = 1 \text{ MHz}$ | | C_j | | 15 | | pF |

| CROSSING TABLE | |
|----------------|---------|
| VISHAY | OSRAM |
| VLMRY3420 | LAYT67B |

| LUMINOUS INTENSITY CLASSIFICATION AND GROUP COMBINATIONS, VLMRY3420 ¹⁾ | | | | | |
|---|-----------------------|----------------------|----------------------|----------------------|----------------------|
| | | RED | | | |
| | | T2 355 to 450 mcd | U1 450 to 560 mcd | U2 560 to 710 mcd | V1 710 to 900 mcd |
| Y E L L O W | U2 560 to 710 mcd | VLMRY3420 | VLMRY3420 | VLMRY3420 | VLMRY3420 |
| | V1 710 to 900 mcd | VLMRY3420 | VLMRY3420 | VLMRY3420 | VLMRY3420 |
| | V2 900 to 1120 mcd | VLMRY3420 | VLMRY3420 | VLMRY3420 | VLMRY3420 |

Note:

¹⁾Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of $\pm 11\%$.

| COLOR CLASSIFICATION | | | |
|----------------------|--------------------------|--|-----|
| GROUP | DOMINANT WAVELENGTH (NM) | | |
| | YELLOW | | |
| | MIN | | MAX |
| 1 | 581 | | 584 |
| 2 | 583 | | 586 |
| 3 | 585 | | 588 |
| 4 | 587 | | 590 |
| 5 | 589 | | 592 |
| 6 | 591 | | 594 |

TYPICAL CHARACTERISTICS

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

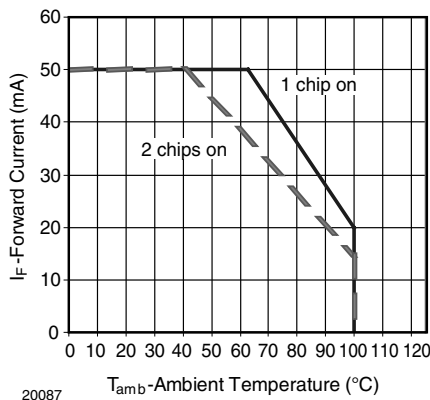


Figure 1. Forward Current vs. Ambient Temperature

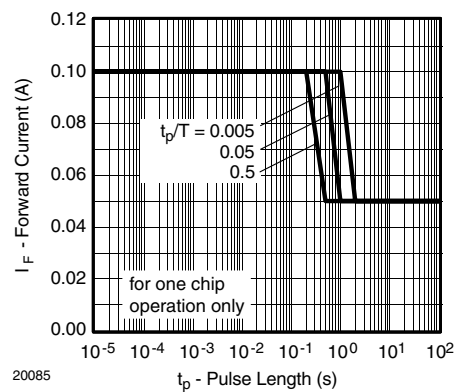


Figure 2. Forward Current vs. Pulse Duration

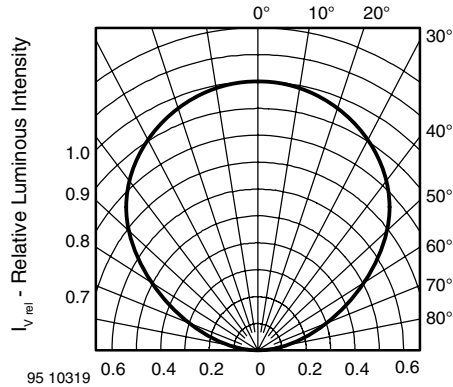


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

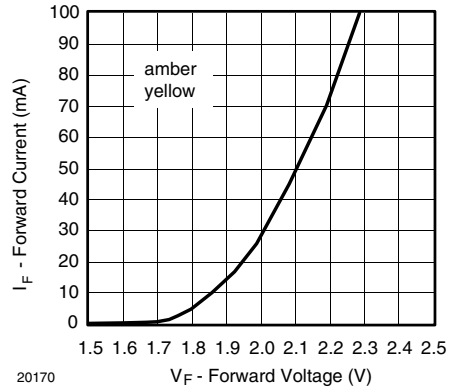


Figure 6. Relative Forward Voltage vs. Ambient Temperature

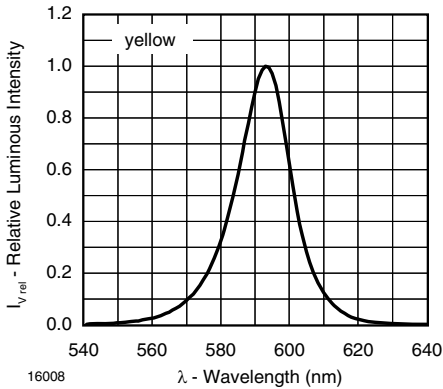


Figure 4. Relative Intensity vs. Wavelength

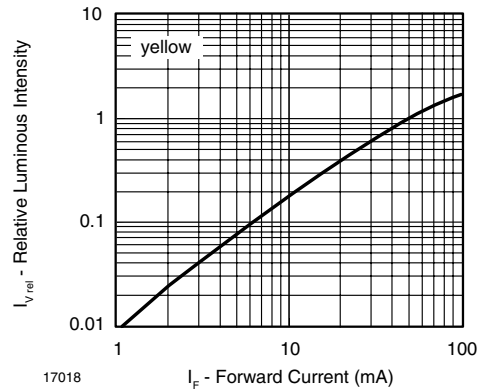


Figure 7. Relative Luminous Intensity vs. Forward Current

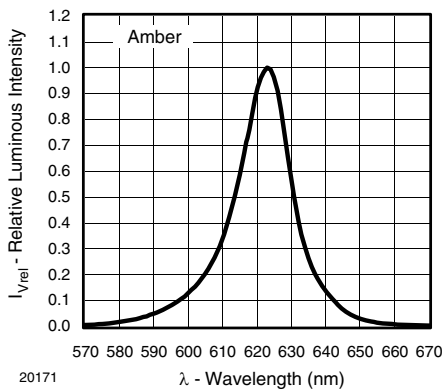


Figure 5. Relative Intensity vs. Wavelength

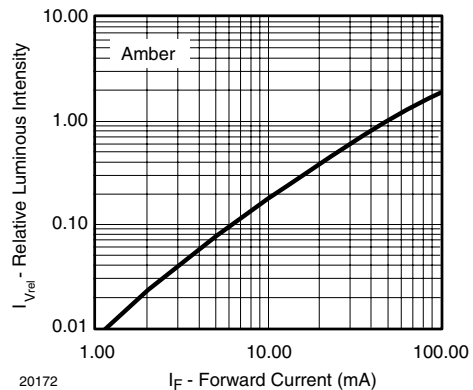


Figure 8. Relative Luminous Intensity vs. Forward Current

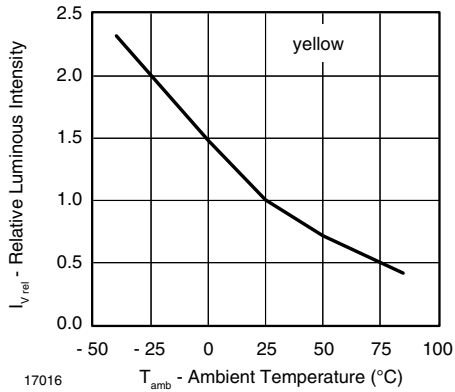


Figure 9. Rel. Luminous Intensity vs. Ambient Temperature

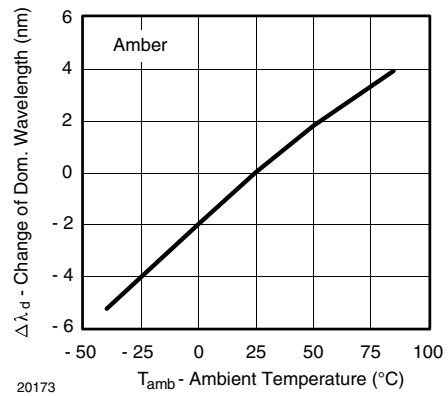


Figure 12. Change of Dominant Wavelength vs. Ambient Temperature

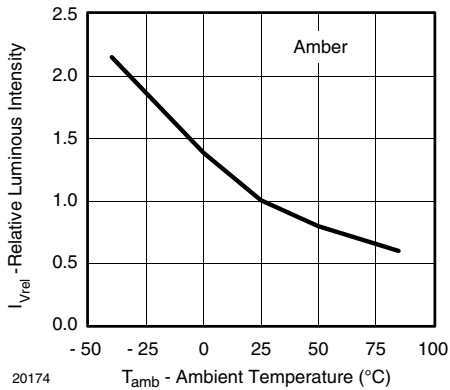


Figure 10. Rel. Luminous Intensity vs. Ambient Temperature

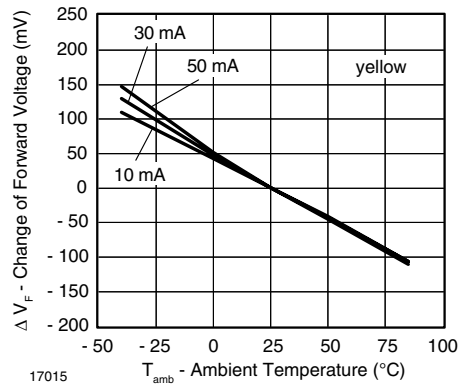


Figure 13. Change of Forward Voltage vs. Ambient Temperature

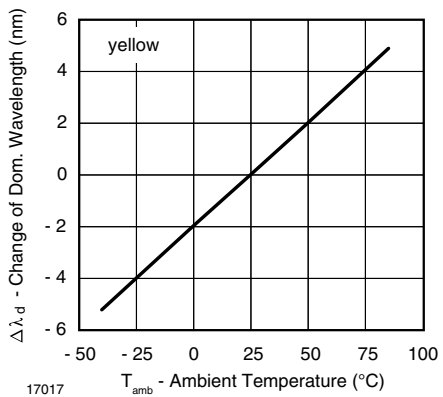


Figure 11. Change of Dominant Wavelength vs. Ambient Temperature

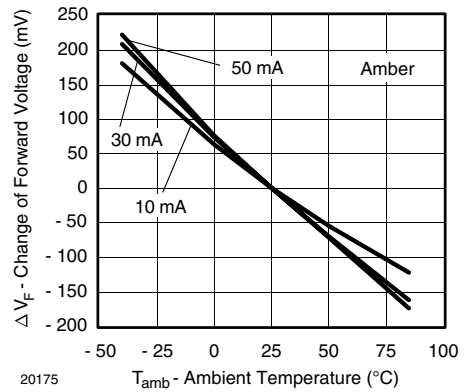
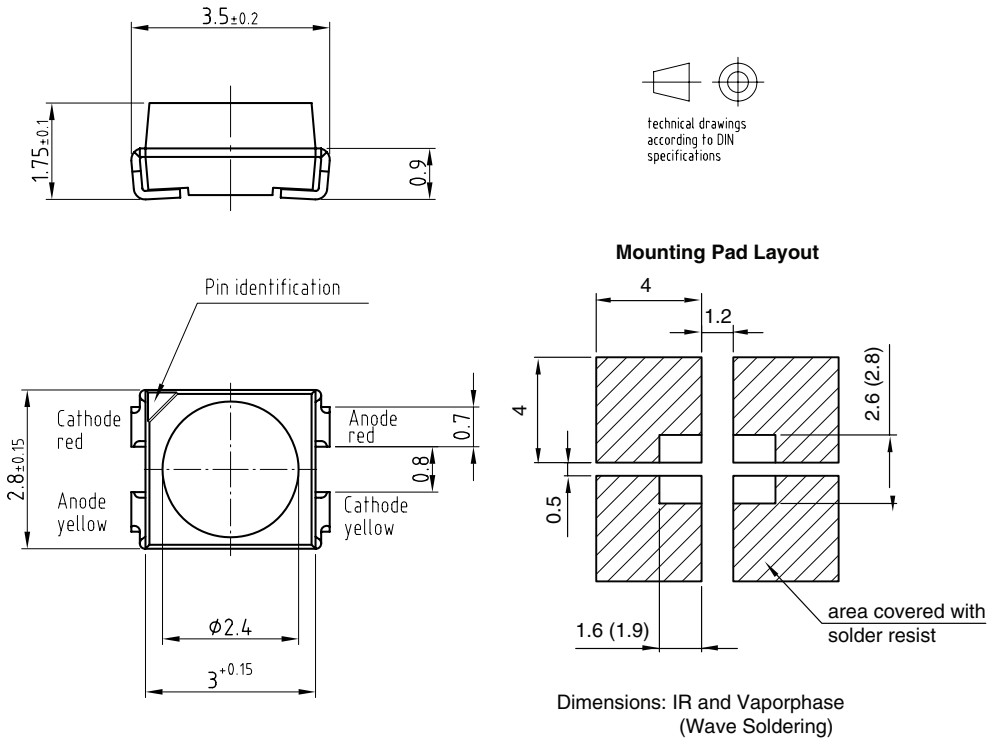


Figure 14. Change of Forward Voltage vs. Ambient Temperature

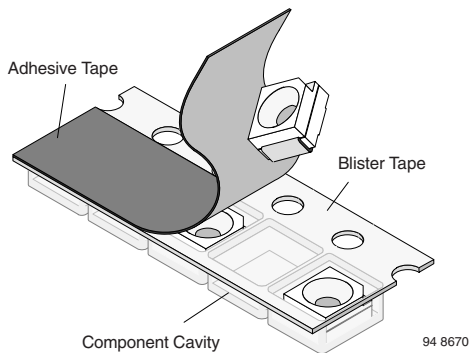
PACKAGE DIMENSIONS



Drawing-No.: 6,541-5057.01-4
 Issue: 5, 30.05.07
 19899

**METHOD OF TAPING/POLARITY AND TAPE AND REEL
 SMD LED (VLM.3 - SERIES)**

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertion. The blister tape is a plastic strip with impressed component cavities, covered by a top tape.



TAPING OF VLM.3...

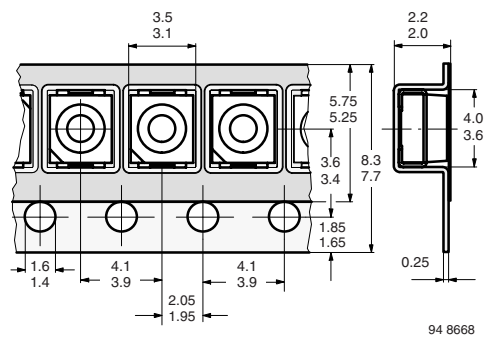


Figure 15. Tape Dimensions in mm for PLCC-2

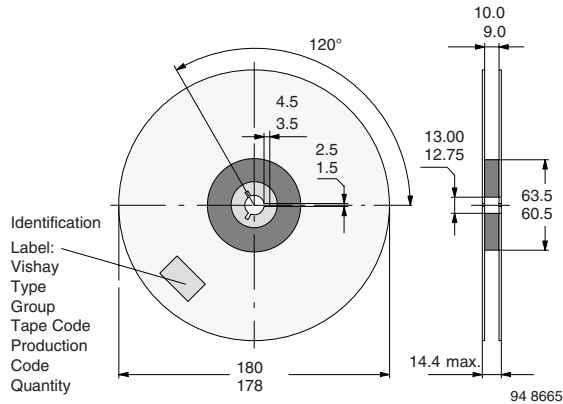
**REEL PACKAGE DIMENSION IN MM FOR
SMD LEDS, TAPE OPTION GS08
(= 1500 PCS.)**


Figure 16. Reel Dimensions - GS08

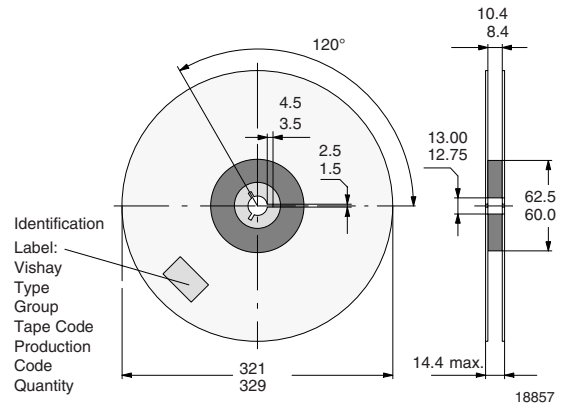
**REEL PACKAGE DIMENSION IN MM FOR
SMD LEDS, TAPE OPTION GS18
(= 8000 PCS.) PREFERRED**


Figure 17. Reel Dimensions - GS18

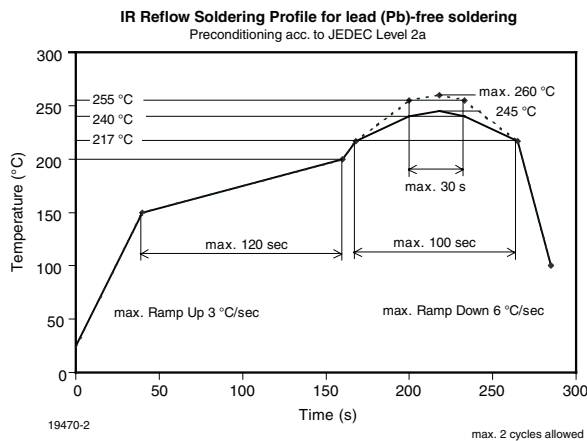
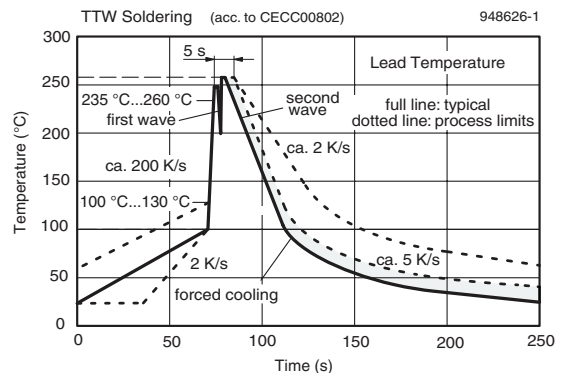
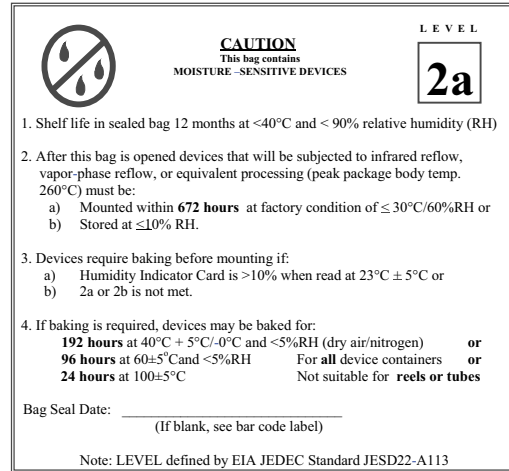
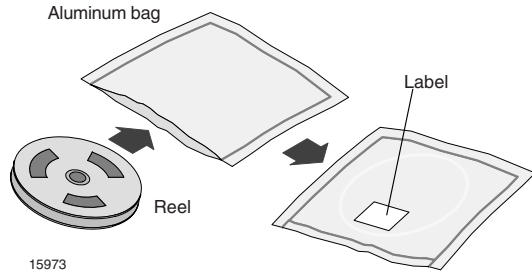
SOLDERING PROFILE

 Figure 18. Vishay Lead (Pb)-free Reflow Soldering Profile
(acc. to J-STD-020C)


Figure 19. Double Wave Soldering of Opto Devices (all Packages)

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



Example of JESD22-A112 level 2a label

FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminium bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10°C to 30°C
- Storage humidity $\leq 60\%$ RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

- 192 h at $40^{\circ}\text{C} + 5^{\circ}\text{C}/ - 0^{\circ}\text{C}$ and <math><5\%</math> RH (dry air/nitrogen) or
- 96 h at $60^{\circ}\text{C} + 5^{\circ}\text{C}$ and <math><5\%</math> RH for all device containers or
- 24 h at $100^{\circ}\text{C} + 5^{\circ}\text{C}$ not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

**OZONE DEPLETING SUBSTANCES POLICY STATEMENT**

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



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Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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Email: org@lifeelectronics.ru